505542812 06/25/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT

EPAS ID: PAT5589609

CONVEYING PARTY DATA

NATURE OF CONVEYANCE:

Name	Execution Date
CHING-KAI SHEN	06/04/2019
YI-CHUAN TENG	06/04/2019
WEI-CHU LIN	06/04/2019
HUNG-WEI LIANG	06/04/2019
JUNG-KUO TU	06/04/2019

ASSIGNMENT

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16426575

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	06/25/2019

Total Attachments: 2

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PATENT REEL: 049579 FRAME: 0653

Your Ref: 120190247US00

US ONLY

ASSIGNMENT

WHEREAS, I(we), SHEN, CHING-KAI, TENG, YI-CHUAN, LIN, WEI-CHU, LIANG, HUNG-WEI and TU, JUNG-KUO whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD FOR THE SAME

SA	ME	
(herematter referred to as the INVENTION) for which an a is executed on even date herewith unless at least one of the United States Design Patent was executed on: Stilled on: 30 May 2019 Se	he following is checked:	s Patent /Utility Patent
☐ established by PCT International Patent Applicat United States of America ☐ issued onas U.S. Patent No.		designating the
WHEREAS. TAIWAN SEMICONDUCTOR MAN address is NO.8, LI-HSIN RD. 6, HSINCHU S hereinafter referred to as ASSIGNEE, is desirous of acquire the United States and its territorial possessions;	SCIENCE PARK, HSINCHU	TAIWAN ROC
NOW, THEREFORE, for good and valuable consider ASSIGNOR, by these presents do sell, assign and transfer and to said INVENTION and application throughout the Patent granted on any division, continuation, continuation terms for which the same may be granted, including all p	unto said ASSIGNEE, the entire rig United States of America, includ n-in-part and reissue of said apolics	ght, title, and interest in ing any and all Letters ation for the full term or
ASSIGNOR further covenants that no assignments, a or entered into which would conflict with this Assignment	sale, agreement or encumbrance hi	is been or will be made
ALSO, ASSIGNOR hereby agrees to execute any docutiling, prosecution and maintenance of said application said invention, including additional documents that mesaid invention, all without further consideration. AS ASSIGNES expense, to identify and communicate to AS concerning the Invention that are within ASSIGNOR'S petestimony on behalf of ASSIGNEE that lawfully may be testimony on behalf of ASSIGNEE that lawfully may be maintenance, litigation and defense of any patent application. ASSIGNOR'S obligations under this instantinistrators and other legal representatives.	or any other patent application(s) ay be required to affirm the rights SIGNOR also agrees, without furth SIGNEE at ASSIGNEE's request docussession or control, and to provide required of ASSIGNOR in resplication or patent encompassed we	in the United States for of ASSIGNEE in and to er consideration and at uments and information e further assurances and ect of the prosecution, (thin the terms of this
ALSO, ASSIGNOR hereby authorizes and requests the and all Letters Patent referred to above to ASSIGNEE, as to the same, for ASSIGNEE'S sole use and behoof; and for the successors, to the full end of the term for which such Lesame would have been held by ASSIGNOR had this assign	he ASSIGNEE of the entire right, in te use and behoof of ASSIGNEE'S it, etters Patent may be granted, as f	de and interest in and to
Assignor Name SHEN, CHING-KAI	Address 6F., NO.102, FUZHU ST. HSINCHU COUNTY 302, TA	., ZHUBEL CITY, AIWAN (R.O.C.)
Signature of Assignar (X) Show Ching - Kai	Date of Signature (X) >019, 6, 4	
Name of Witness (apitional)	Name of Witness (optional)	***************************************
Signature of Witness (optional)	Signature of Witness (Omional)	

PATENT REEL: 049579 FRAME: 0654

Assigner Name TENG, YI-CHUAN	6F., NO.79, JIAQIN N. RD., ZHUBEI CITY, HSINCHU COUNTY 302, TAIWAN (R.O.C.)
Signature of Assignor (X) Lanc (N) - Chown	Date of Signature (X) 20/4/46/04
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name LIN, WEI-CHU	Address 4F., NO. 13, ALY. 2, LN. 452, BAOSHAN RD., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
Signature of Assignor (X) Lin, WEI-CHU	Date of Signature (X) 2919/6/4
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Winess (Optional)

Assignor Name LIANG, HUNG-WEI	Address 6F., NO. 2. ALY. 50, LN. 130, HOUGANG IST RD., XINZHUANG DIST., NEW TAIPEI CITY 242, TAIWAN (R.O.C.)
Signature of Assignor (X) LIANG, HUNG-WEI	Date of Signature (X) \(\sigma_0\) 4 4
Name of Witness (optional)	Name of Winess (optional)
Signature of Witness (optional)	Signature of Wirness (Optional)

Assignor Name TU, JUNG-KUO	NO.2, ALY. 35, LN. 706, NANDA RD., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
Signature of Andrew (X)	Date of Signature (X) Tol9 106 04
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Wilness (Optional)

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